

Interfacial Defect Structure at a twin boundary in Bi_2Te_3

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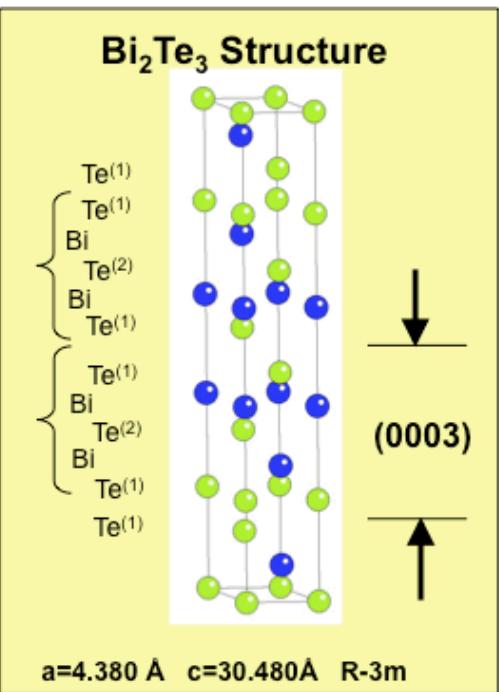
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Control of Grain Structure important to Bi_2Te_3 -Based Thermoelectrics



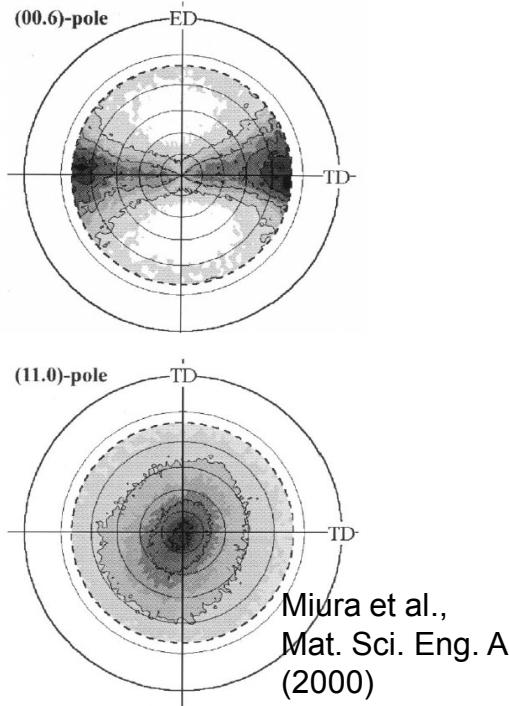
• Layered Crystal Structure

- anisotropic TE properties
- optimal zT parallel with basal planes
- anisotropic mass diffusivities
- easy fracture on basal planes

Microstructural Strategies applied to Bi_2Te_3 -based materials

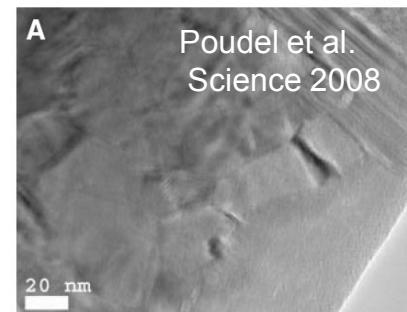
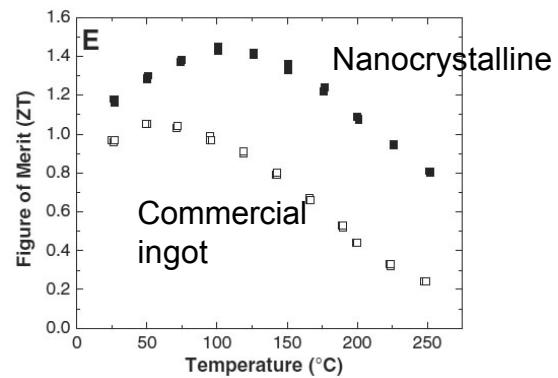
Control of crystal texture

Example: Texture in Hot Extruded Bi_2Te_3



Reduction of Grain Size

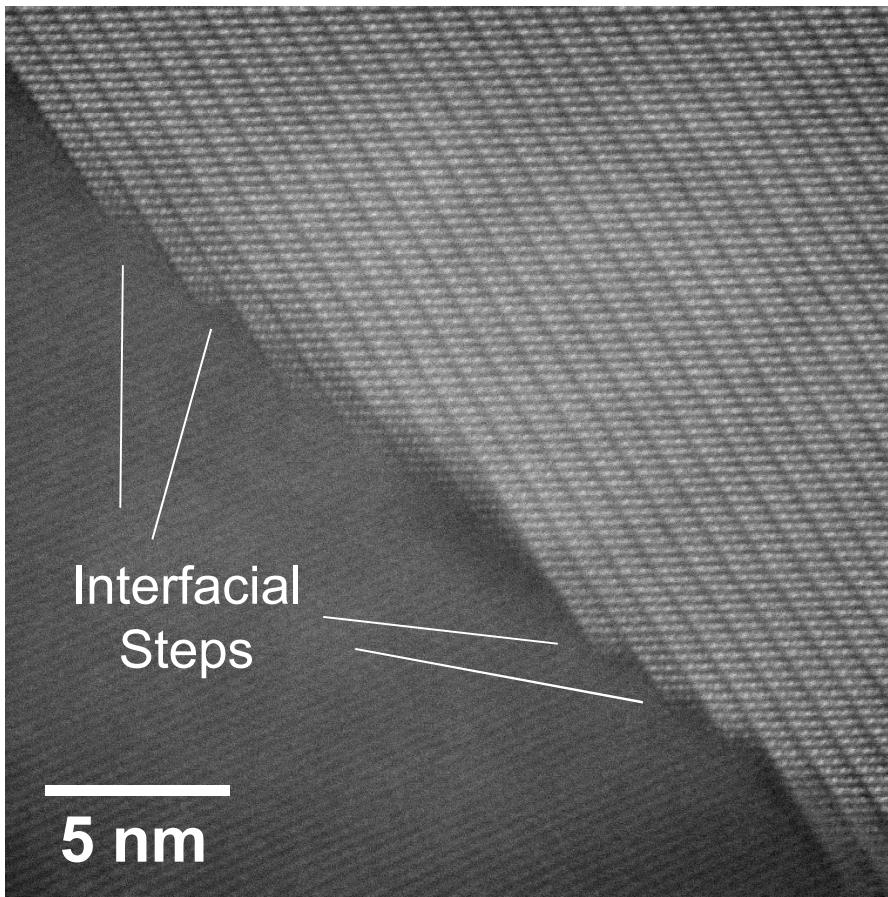
Example: Enhanced zT in nanocrystalline $(\text{Bi},\text{Sb})_2\text{Te}_3$



Our goal: Connect interfacial structure to mechanisms governing interfacial behavior

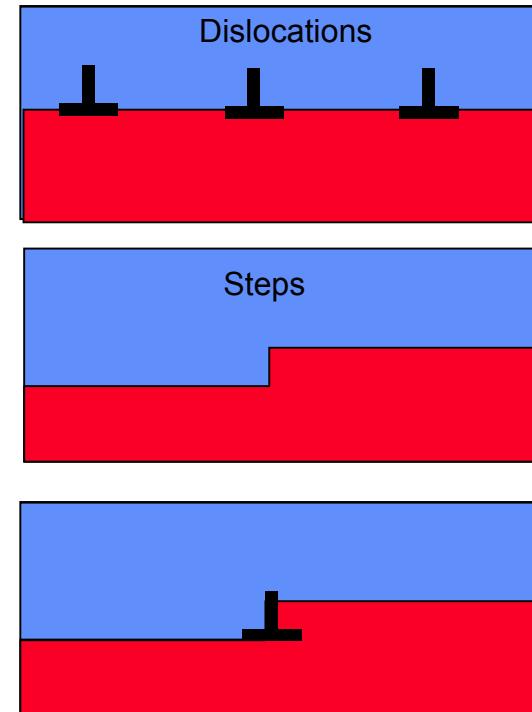
Example:

HAADF-STEM image, Grain Boundary in Bi_2Te_3



Interfacial Defects:

Building blocks to general understanding
of interface structure and behavior

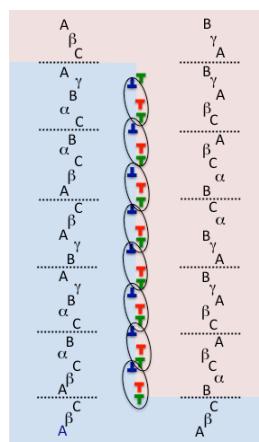
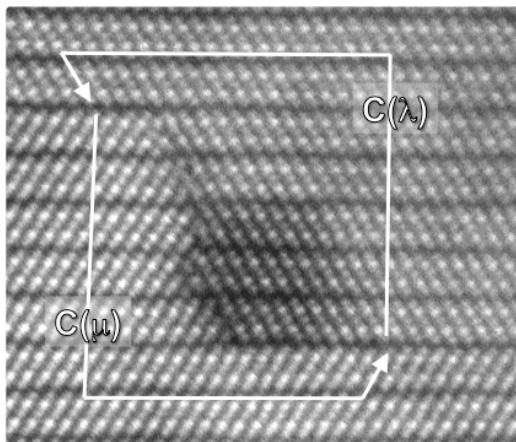
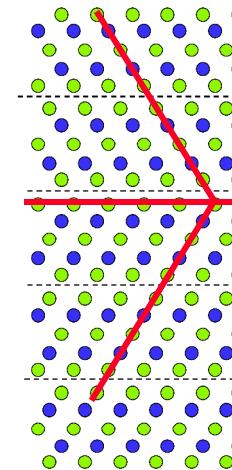


Focus for this talk: (0001) Twins in Bi_2Te_3

Good starting point for more complex grain boundaries

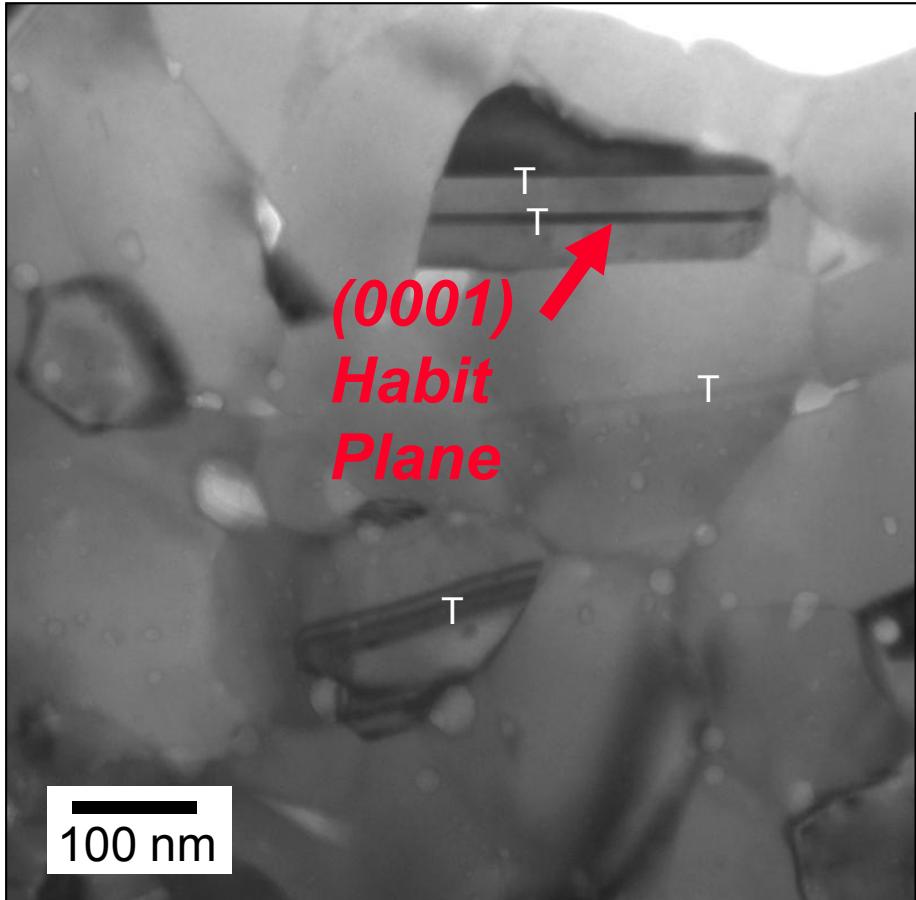
Twins have potential for favorable TE electronic transport properties

-Coherent structure, near bulk-like coordination.



- Structure of the (0001) Basal Twin
 - comparison with *ab initio* calculations
- Analysis of a twin boundary defect: interfacial step
- Analogies to twins in FCC materials

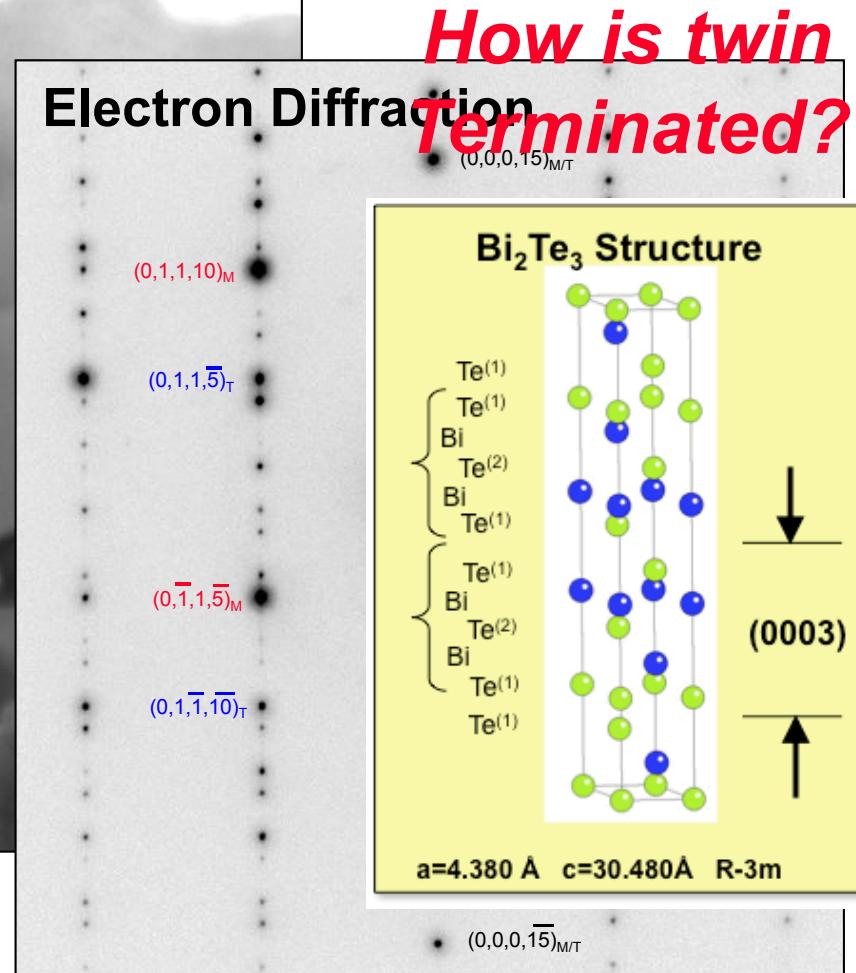
Twin microstructure and crystallography



Bi_2Te_3 : Powder consolidated by spark plasma sintering

TEM Specimen Preparation:
Low voltage ion milling (1kV)
Cryo-cooling: <-100°C

Orientation Relationship:
 $(0001)/(0001)$
 $[2-1-10]/[-2110]$

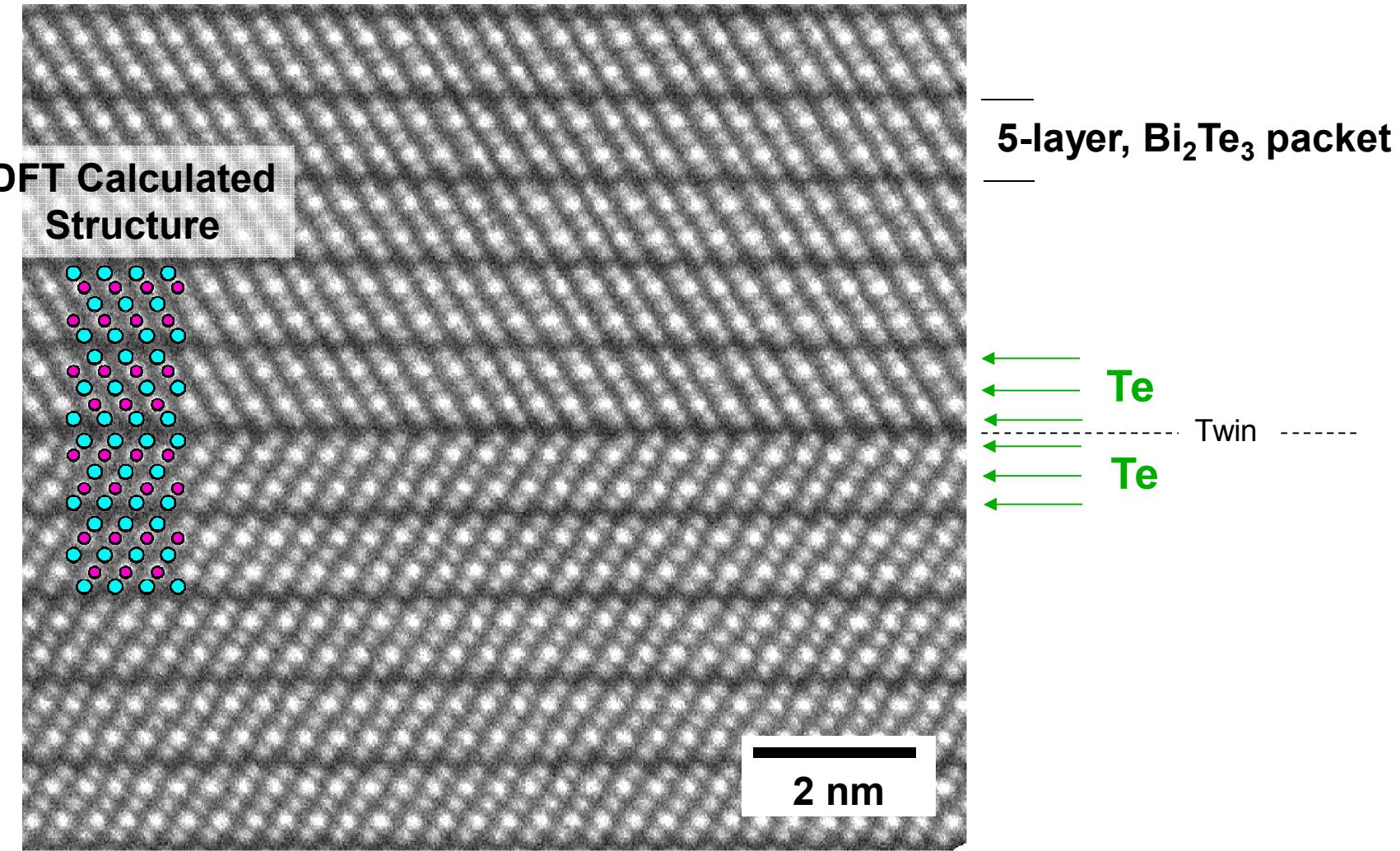


180° rotation about c-axis

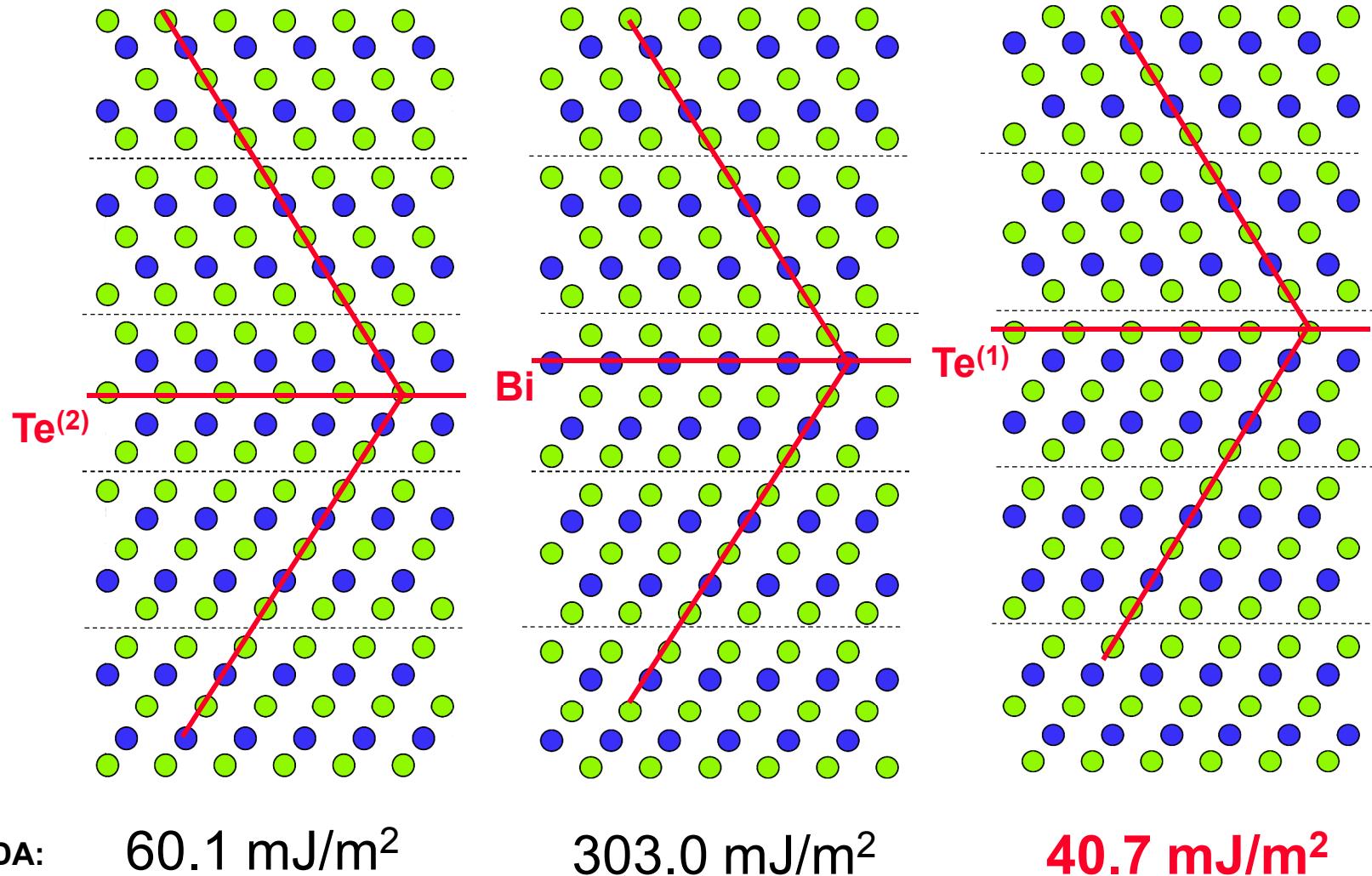


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HAADF-STEM Observations: Twin terminated at Te⁽¹⁾-Te⁽¹⁾ layer



Twin boundary Energy depends on Interface Termination

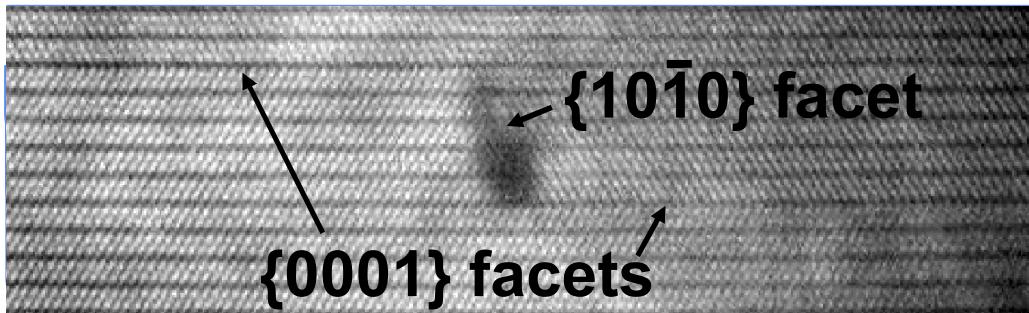


DFT-LDA: 60.1 mJ/m^2

303.0 mJ/m^2

40.7 mJ/m^2

Steps in the Bi_2Te_3 Twin Boundary



5 nm
Steps of integral 5-plane

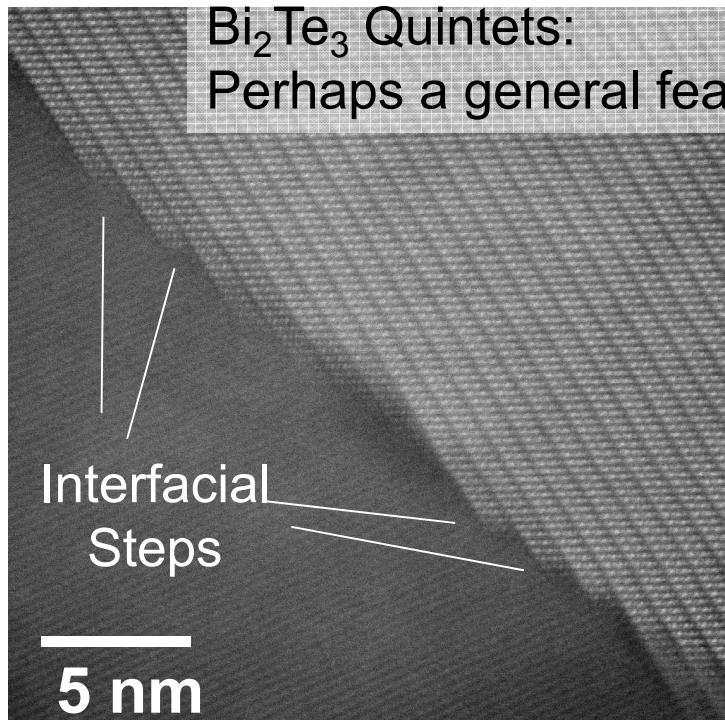
Bi_2Te_3 Quintets:
Perhaps a general feature?

Interfacial
Steps

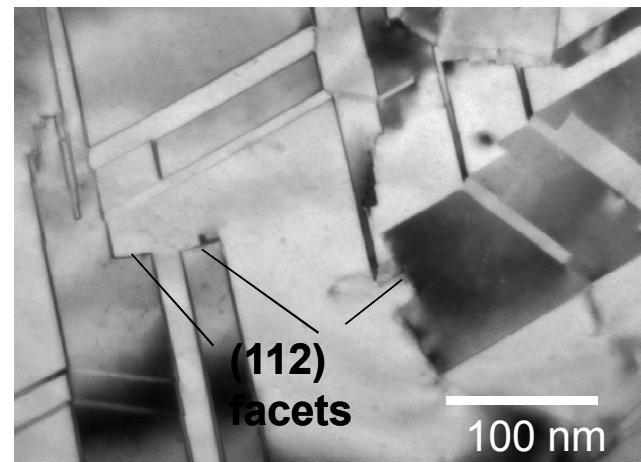
5 nm

NBT20/21mar11/18.15.52

*Morphology analogous
to annealing and growth
twins in FCC materials.*



Example: Twins in Electrodeposited Ni

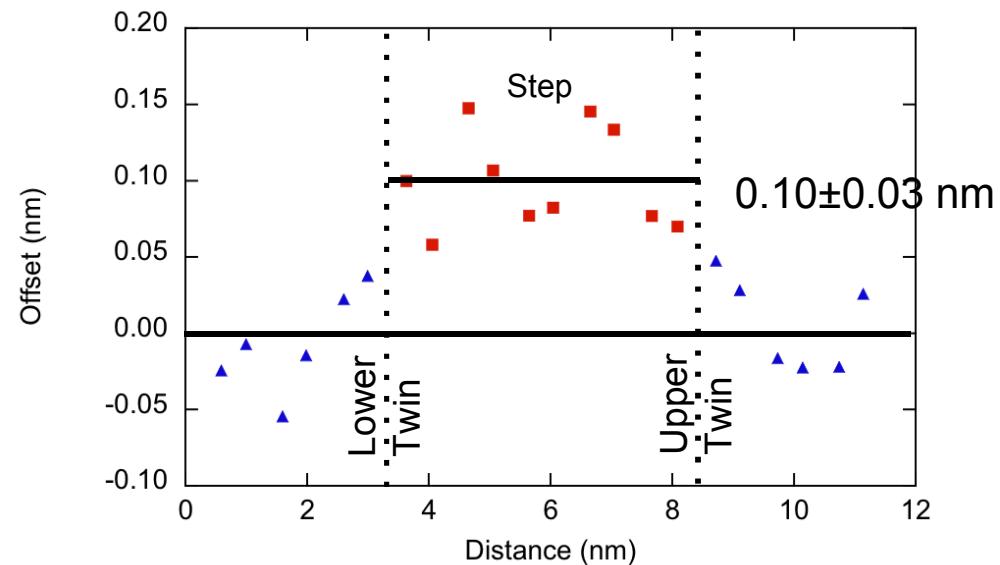
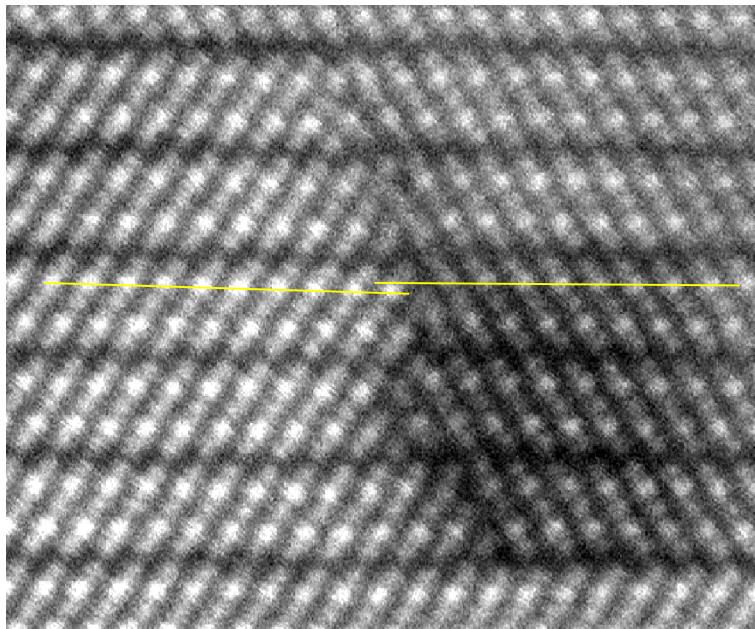


Lucadamo, Medlin, Talin, Yang, Kelly, Phil Mag 2005

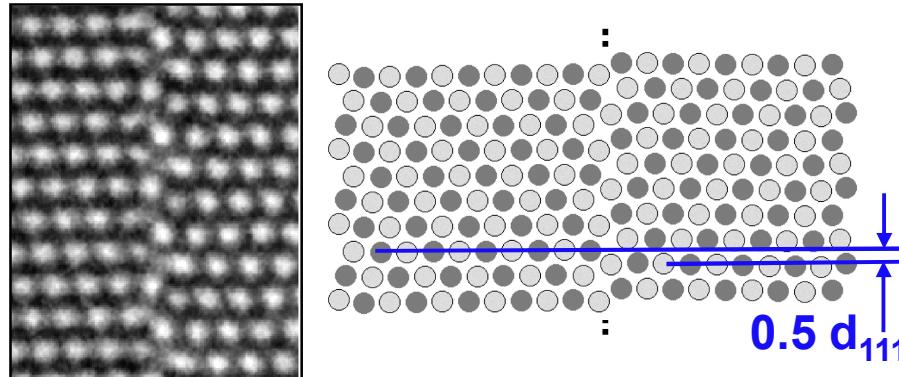


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(0001) Planes are offset at step:



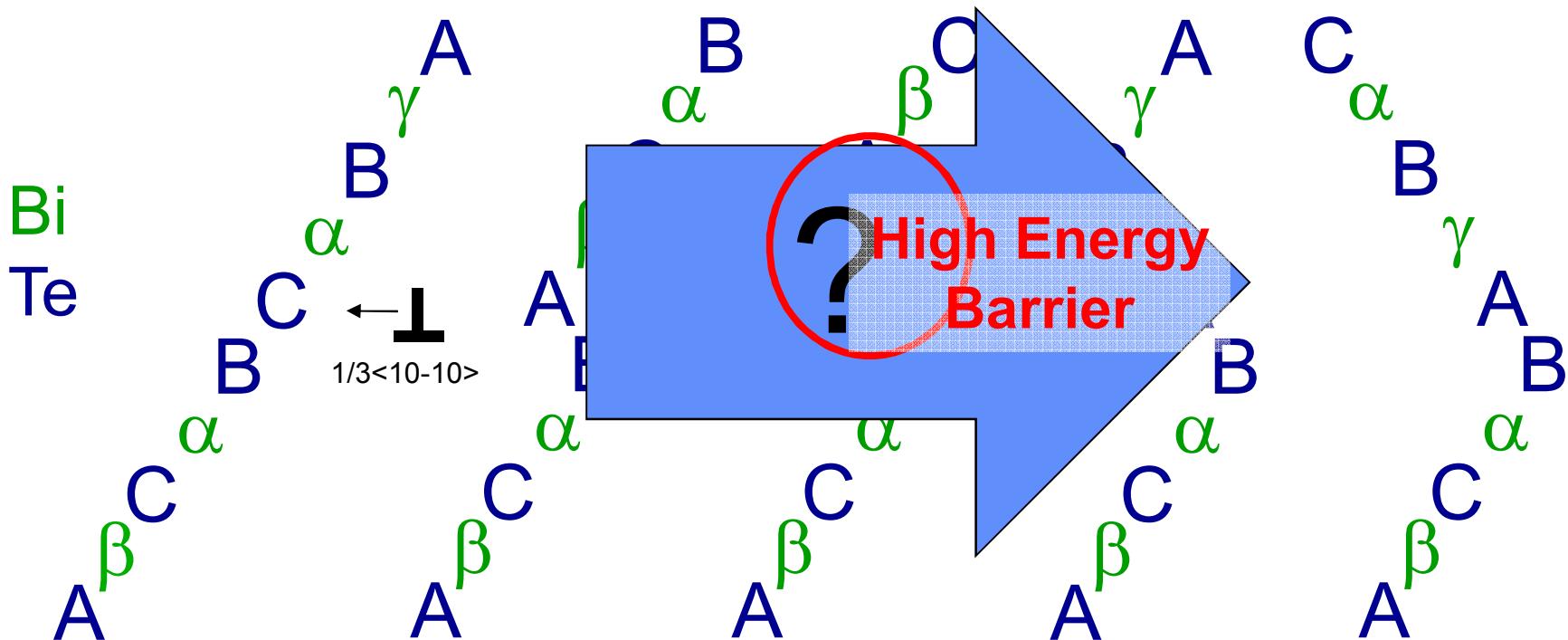
Offset similar to FCC {112} Twins
Example: Gold



Marquis, Hamilton, Medlin, Léonard, Phys. Rev. Lett. (2004)

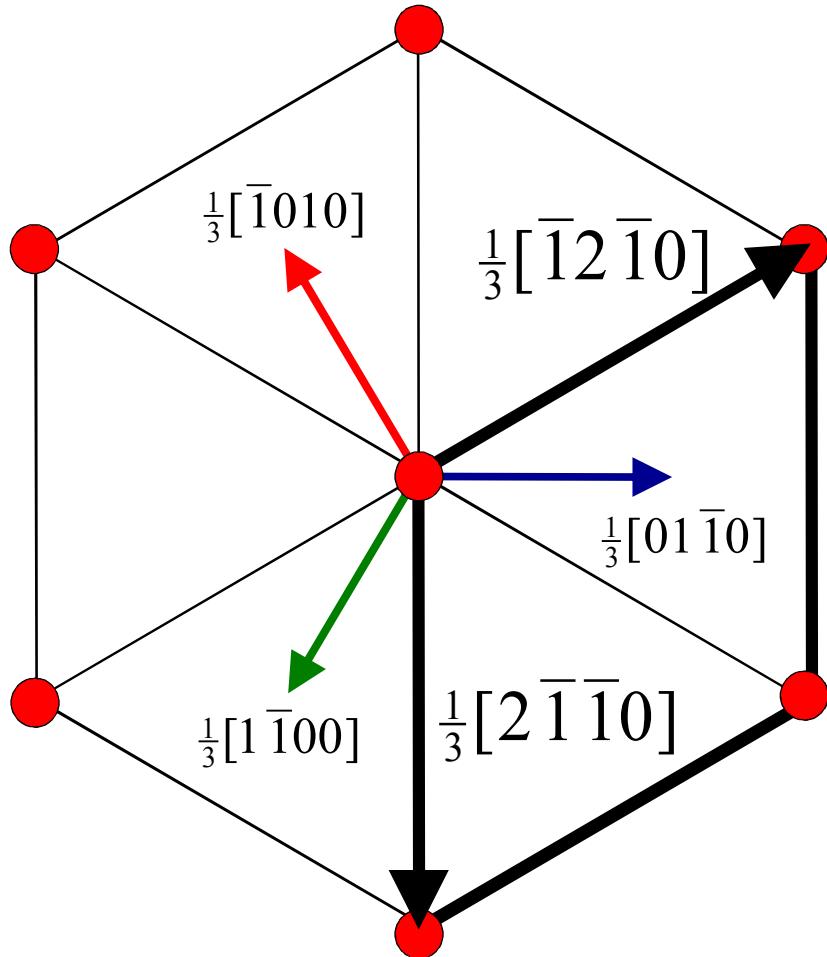
How do twins form in Bi_2Te_3 ?

Sequential motion of twinning dislocations?



- High energy barrier for Bi-terminated interface
→ independent motion of twinning dislocations unlikely.
- Alternative: Coordinated defect motion.
Groupings of *unlike* twinning dislocations

Groupings of 3 allowed twinning dislocations in Bi_2Te_3 structure



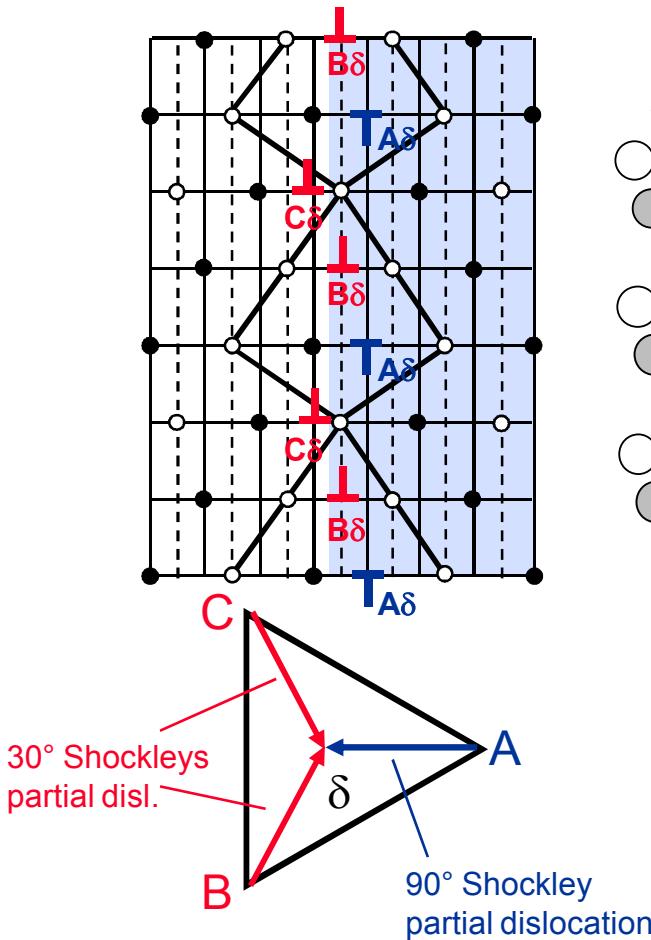
Zero Net Burgers Vector

Three T-shaped symbols are arranged vertically, each consisting of a vertical line segment intersected by a shorter horizontal line segment. The colors of the T-symbols correspond to the dislocation vectors: blue for the top symbol, green for the middle symbol, and red for the bottom symbol.

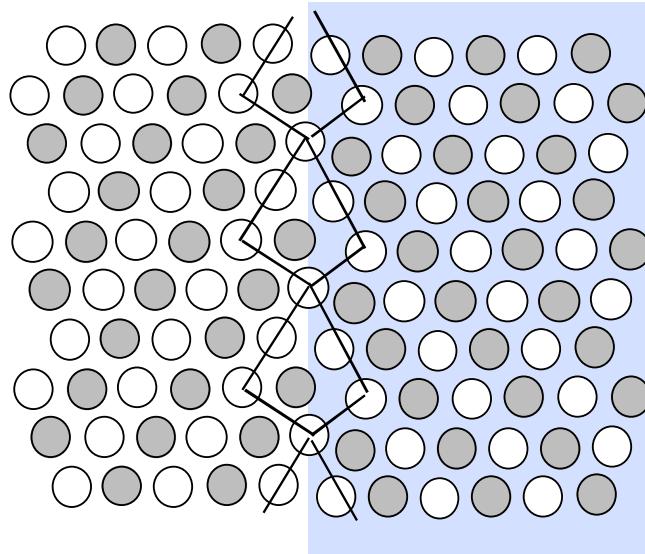
Grouping of 3 twinning dislocations is analogous to FCC {112} twin facets

Example: Aluminum {112} Twin Structure:

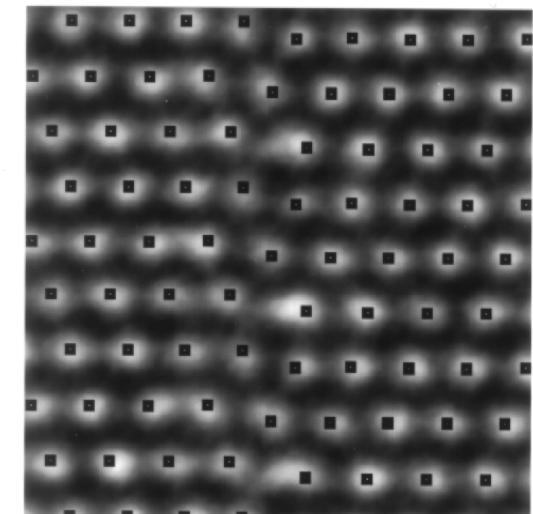
Boundary dislocation arrangement



Relaxed Structure
(Aluminum-Voter & Chen EAM)



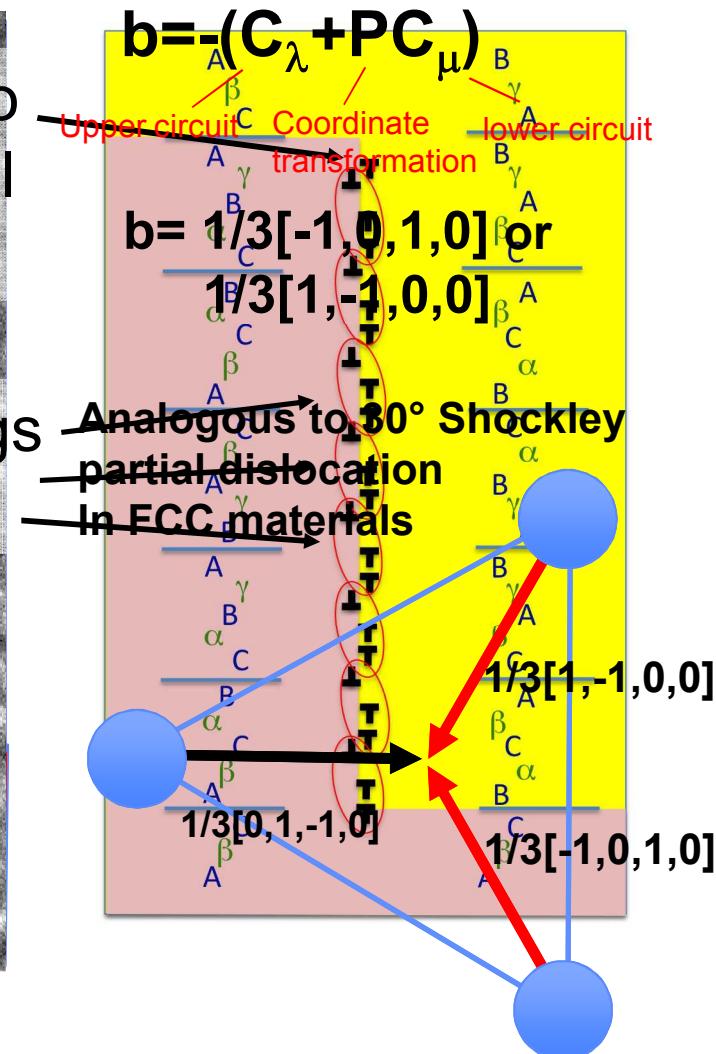
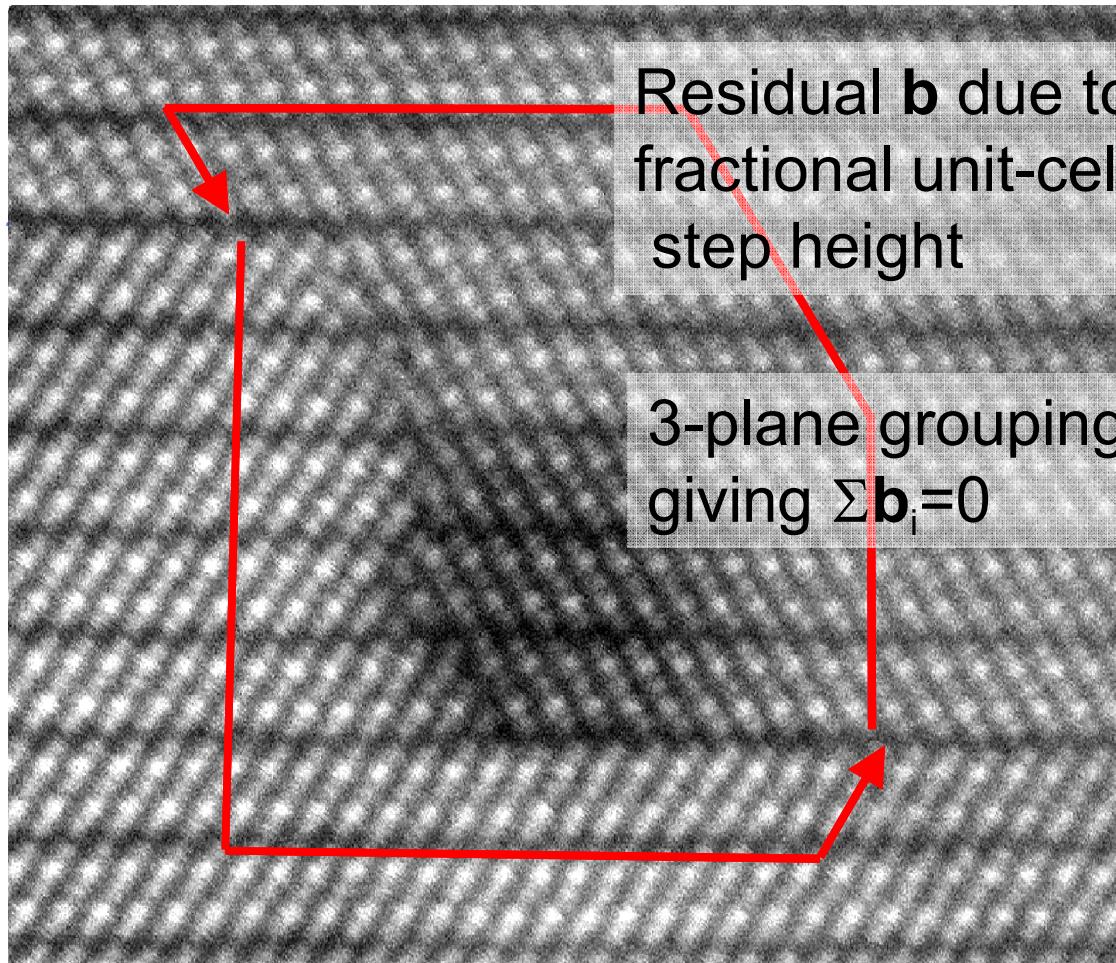
HRTEM



-D.L. Medlin, M.J. Mills, W.M. Stobbs, M.S. Daw, F. Cosandey MRS 295 (1993).
-D.L. Medlin, S.M. Foiles, G.H. Campbell, C.B. Carter, Materials Science Forum (1999).

Facile migration of {112} facets by coordinated motion of 3-layer groupings of 90° and 30° $1/6<112>$ dislocations

What is the dislocation content of the step?



Conclusions

- **Bi₂Te₃ (0001) Twin boundary structure determined.**
 - Termination at Te(1)-Te(1) layer
 - Lowest energy structure from *ab initio* calculations
 - Structure confirmed with HAADF-STEM
- **Twin boundary defect structure:**
 - Analogies to FCC twins and defects.
 - chemical constraint due to energetics of interface termination.
- **Foundation for more general understanding of grain boundary structure in bismuth telluride.**

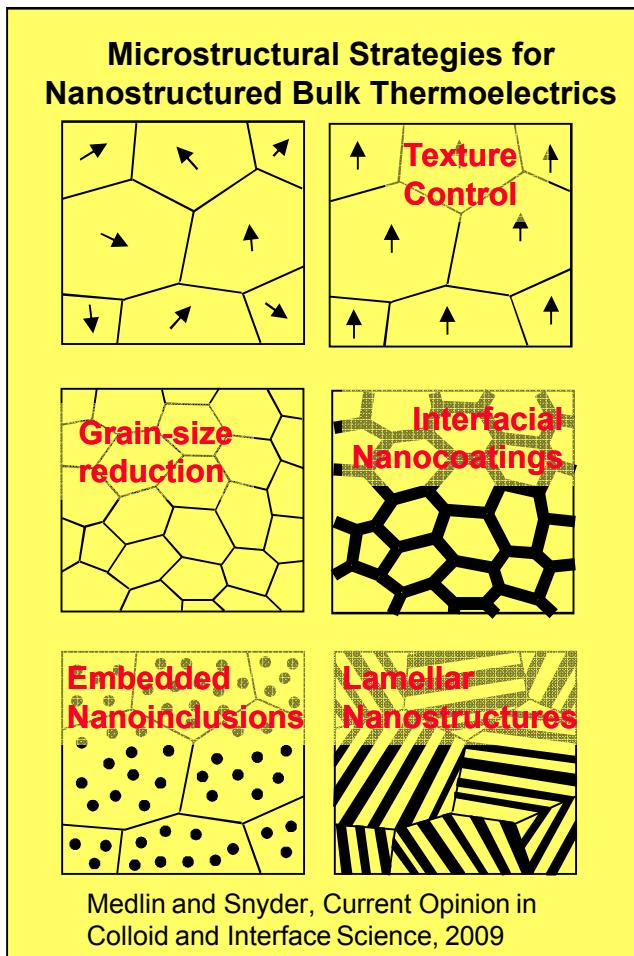
Special thanks to:

- LBNL: User program, National Center for Electron Microscopy
- LLNL: John Bradley, for use for LLNL's Titan 80/300 instrument
- UCD: Z. Zhang and E. Lavernia, for assistance with SPS processing

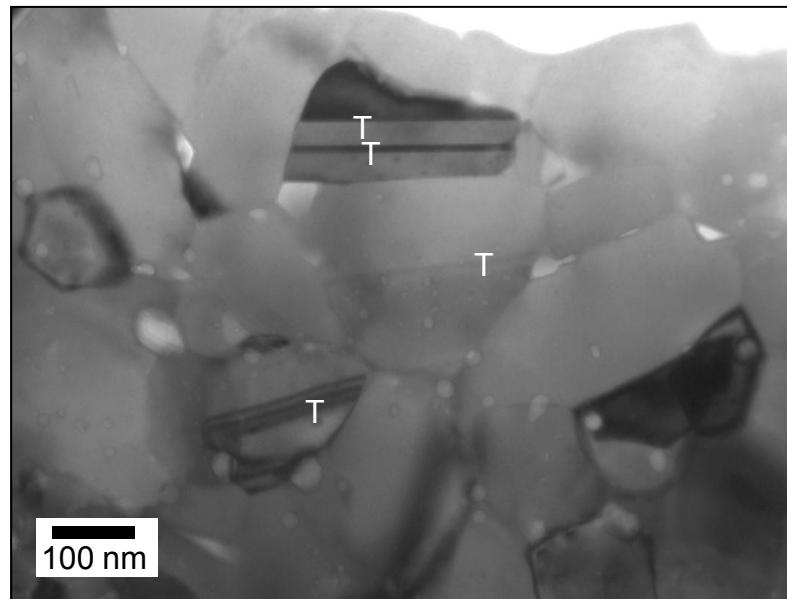
Sandia is a multiprogram laboratory operated by Sandia Corporation, a Lockheed-Martin Company, for the United States Department of Energy, National Nuclear Security Administration under Contract DE-AC04-94AL85000.

Extra

We are investigating interface structure in nanostructured bulk thermoelectrics



Example: Twins in nanocrystalline Bi_2Te_3



Focus of this talk: (0001) Twins in Bi_2Te_3

- Several possible compositional terminations
- HAADF-STEM to determine structure
- Compare with *ab initio* calculations
 - Local relaxations
- Twin formation: dislocation mechanisms

Interest in Grain Boundaries in Bi_2Te_3

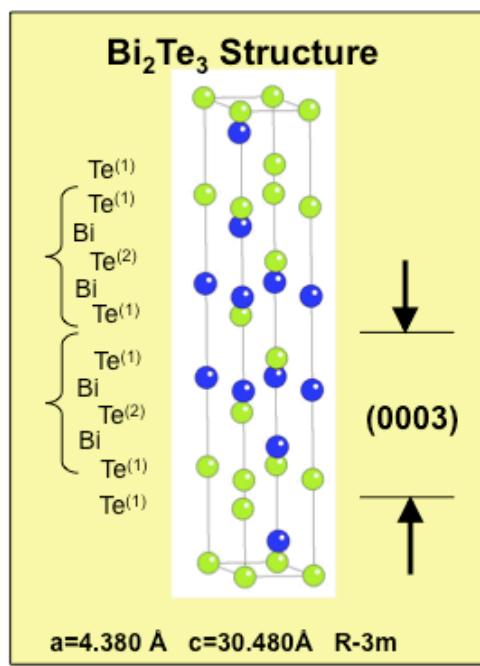
Motivation:

Large Enhancements in zT for nanostructured bulk Bi_2Te_3 ($zT=1.4-1.6$)

Poudel et al Science 2008 $zT=1.4$ @ 100°C

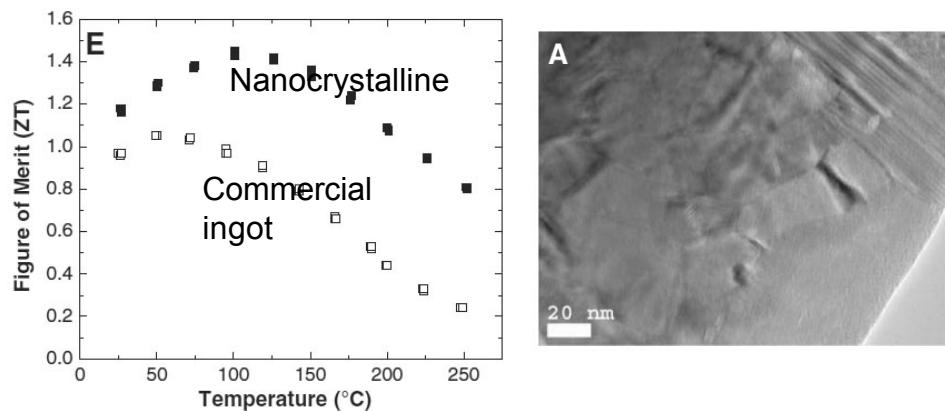
Xie et al, J. Appl. Phys 2009

-Reduced κ , boundary phonon scattering



Enhanced zT in nanocrystalline $(\text{Bi},\text{Sb})_2\text{Te}_3$

Poudel et al. Science 2008



Little is known about GBs in Bi_2Te_3

-Twins make good starting point.

Twins have potential for favorable TE electronic transport properties

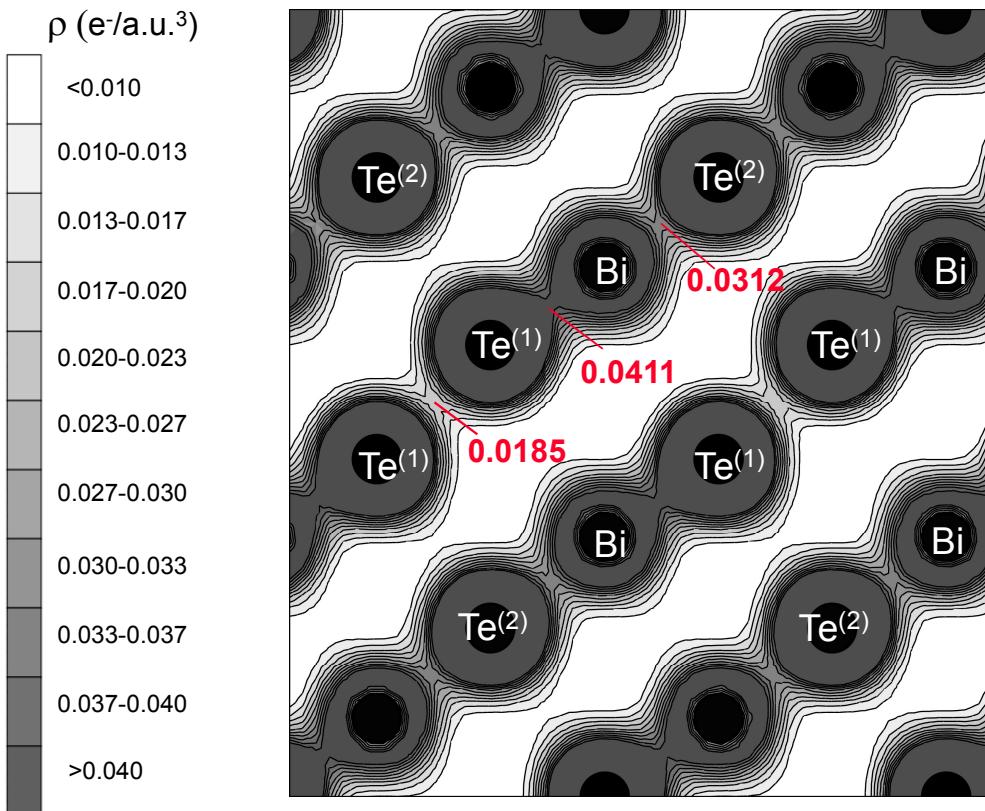
-Coherent structure, near bulk-like coordination.



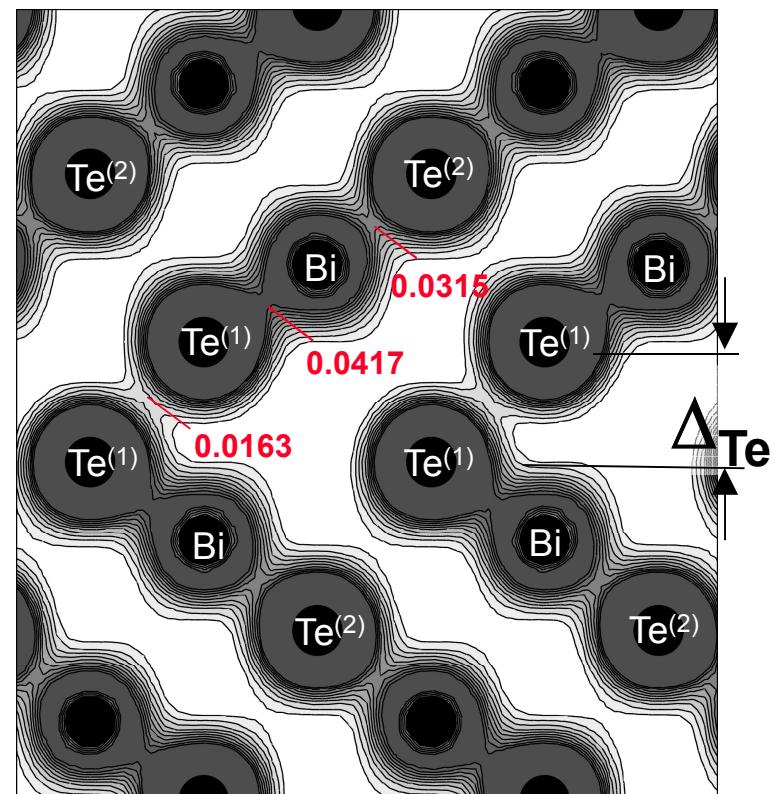
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Calculations predict expansion at interface

Bi_2Te_3 -Perfect Crystal



$\text{Te}^{(1)}$ - $\text{Te}^{(1)}$ Twin

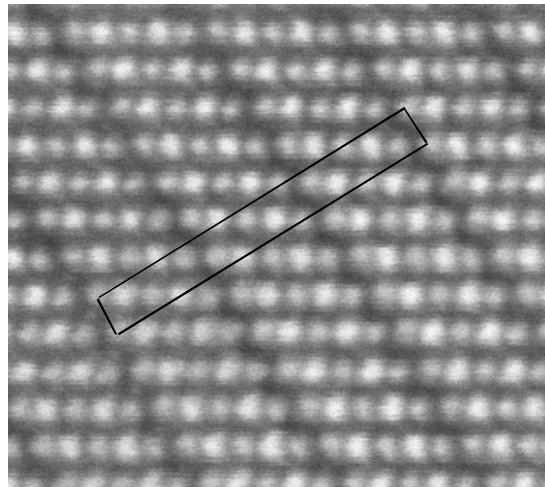
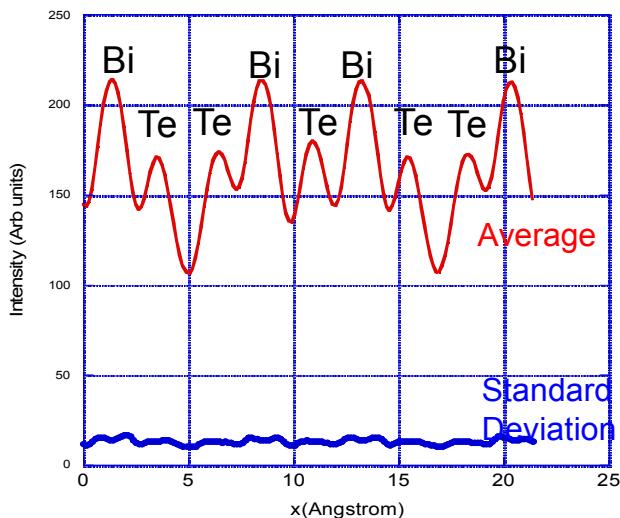
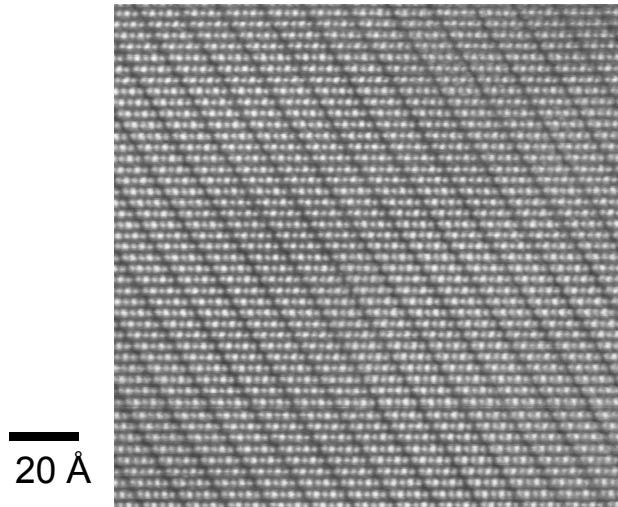


Charge density between $\text{Te}^{(1)}$ - $\text{Te}^{(1)}$ atoms is lower at twin.
Calculations predict expansion normal to interface:

$$\Delta_{\text{Te,interface}} - \Delta_{\text{Te,bulk}} = +0.12\text{\AA}$$

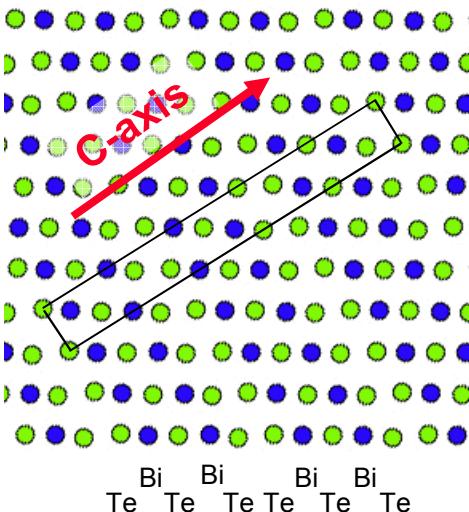
Bi₂Te₃ : High Angle Annular Dark Field STEM

Bi₂Te₃: <2110>Projection



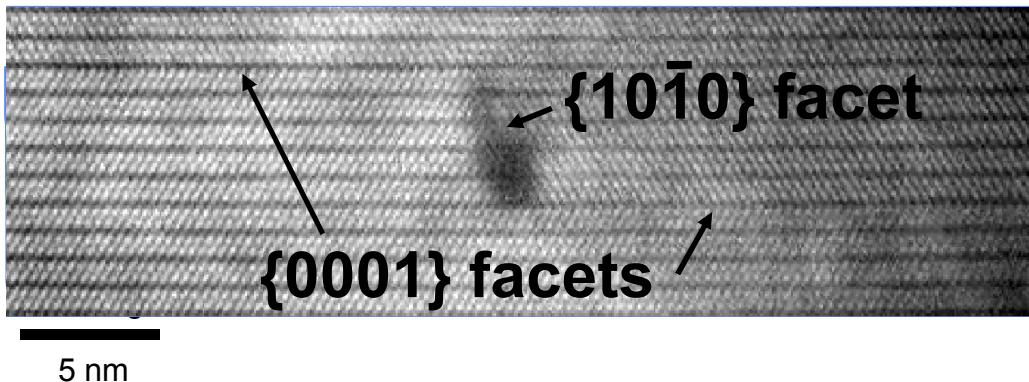
Bi and Te are well Discriminated by HAADF-STEM

Bi: Z=83
Te: Z=52



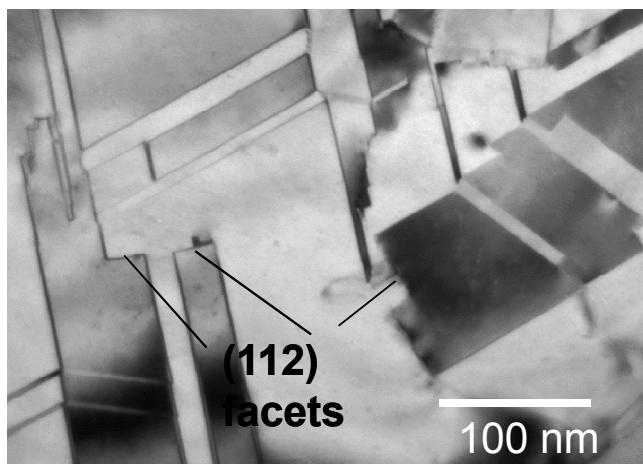
Aberration Corrected TEAM 0.5 Instrument National Center for Electron Microscopy

Steps in the Bi_2Te_3 Twin Boundary

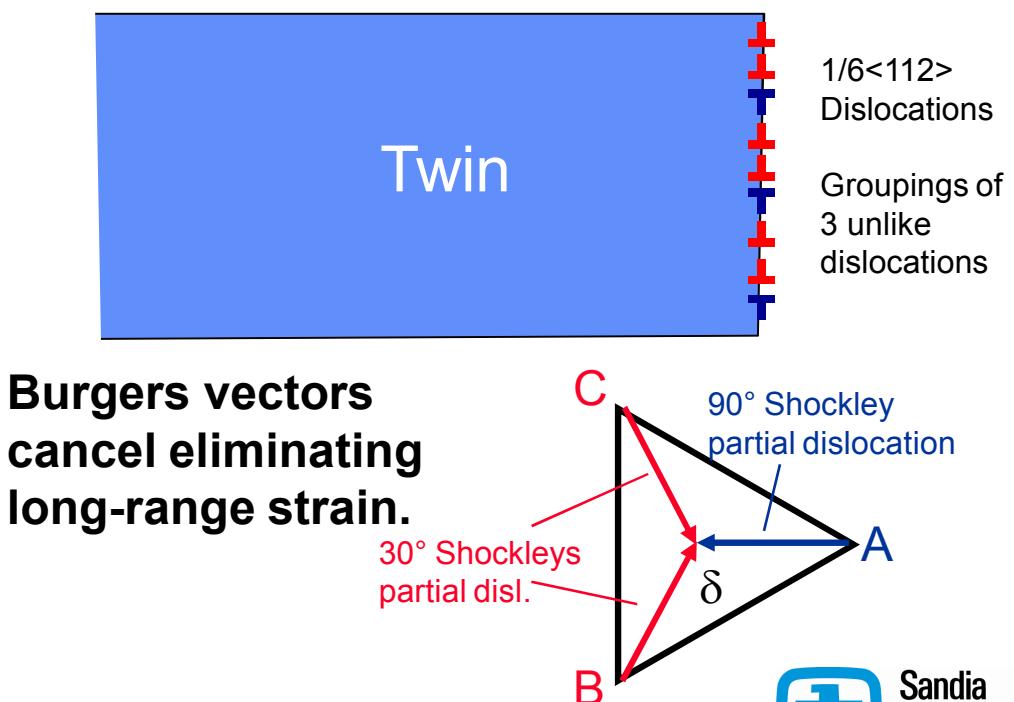


Morphology analogous to annealing and growth twins in FCC materials.

Example: Twins in Electrodeposited Ni

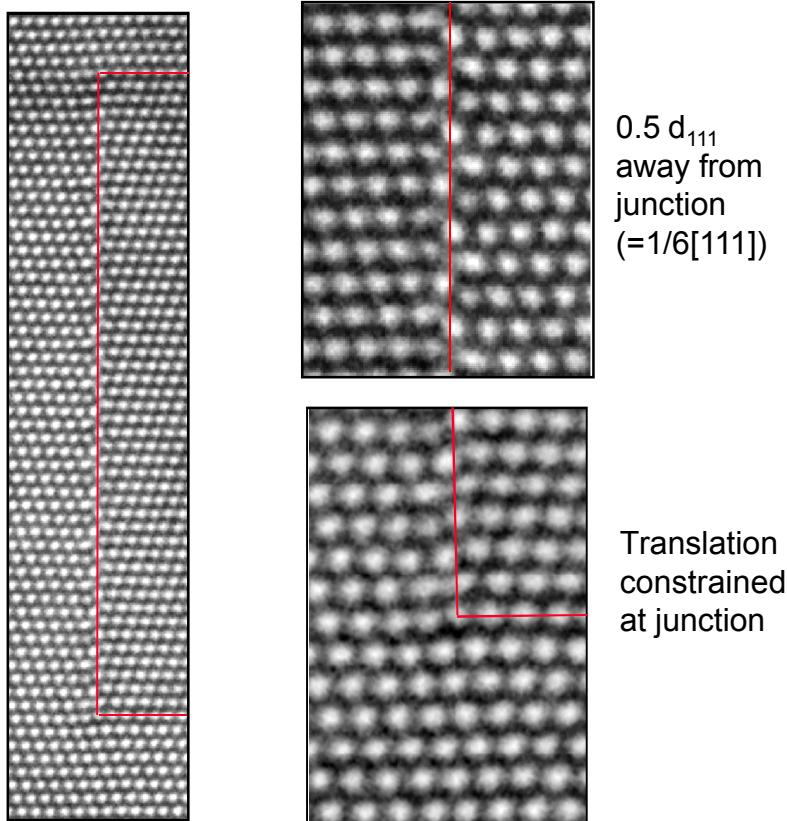


Lucadamo, Medlin, Talin, Yang, Kelly, Phil Mag 2005

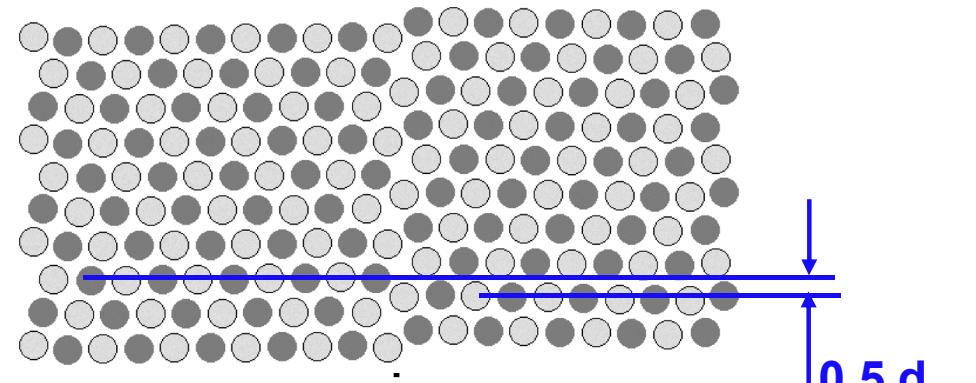


Translation of planes is similar to that observed at FCC $\Sigma=3$ {112} Twin Boundaries

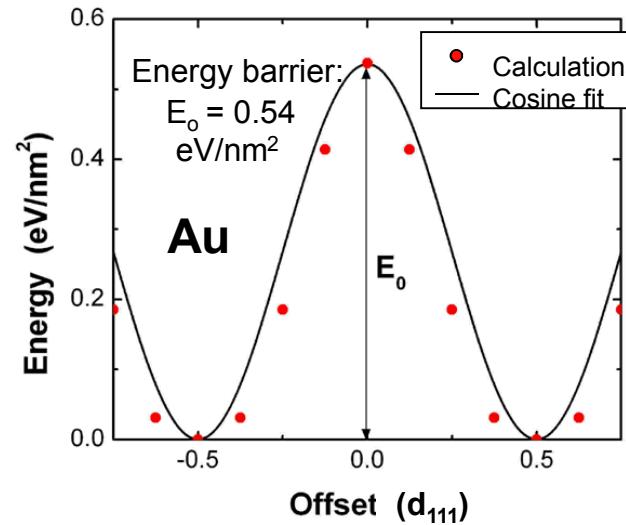
Example: Au $\Sigma=3$ {112}



{111} Planes Offset in
Unconstrained Boundary



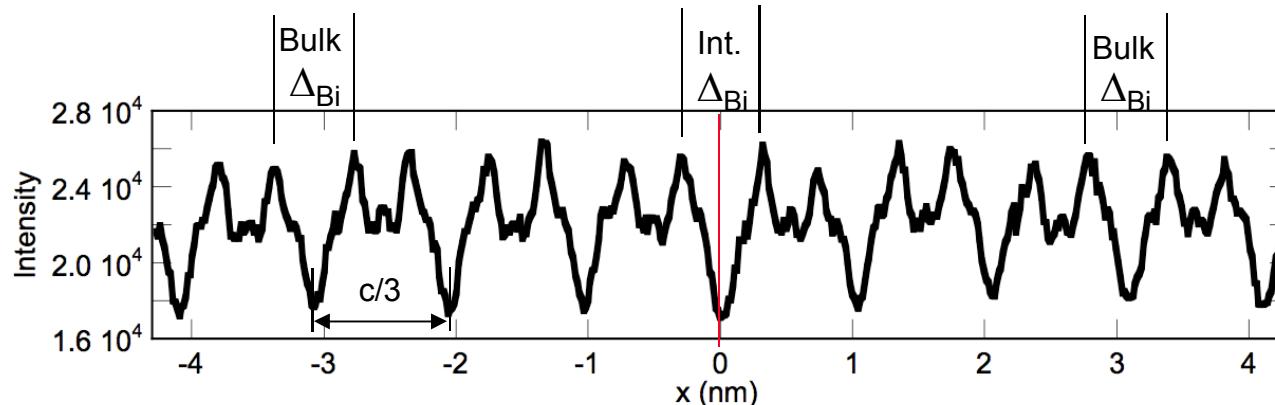
First-principles calculations of GB energy



Marquis, Hamilton, Medlin, Léonard,
Phys. Rev. Lett. (2004)

Experimental measurements confirm expansion

Peak positions measured from intensity line profiles



60 line profiles,
integrated over 8 Å
width
4 independent images

Peak positions refined by
fitting to sum of Gaussians:

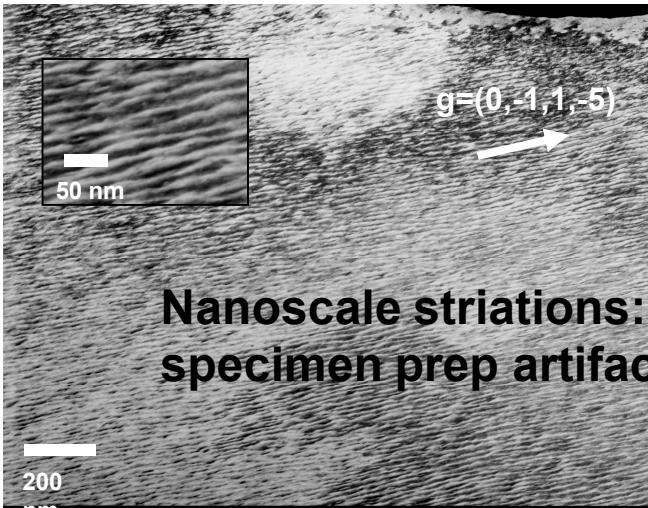
$$I(x) = A_0 + \sum_{i=1}^5 A_i e^{\left[\frac{-(x-x_{0,i})^2}{2\sigma_i^2} \right]}$$

	$\Delta_{int} - \Delta_{bulk}$
Theory	
Te ⁽¹⁾	+0.120 Å
Bi	+0.116 Å
Exp	
	+0.12±0.04 Å
	+0.13±0.03 Å

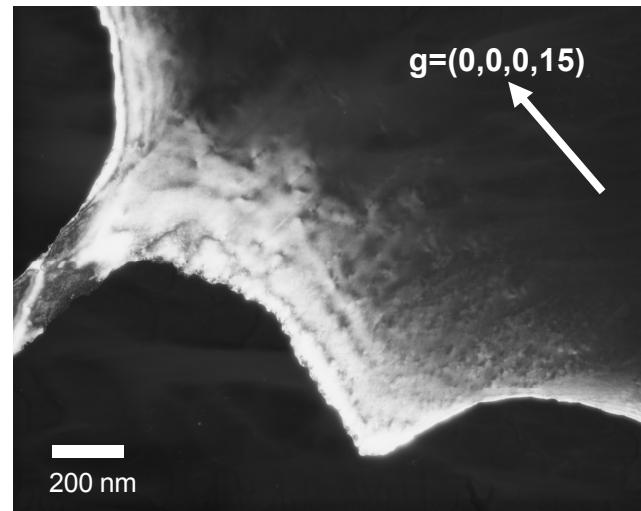
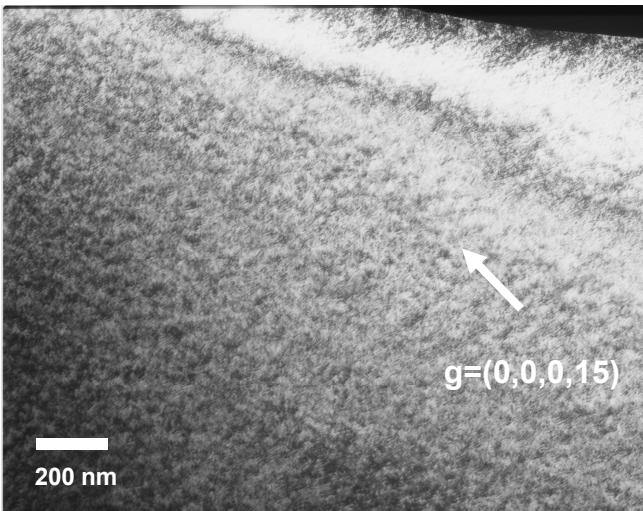
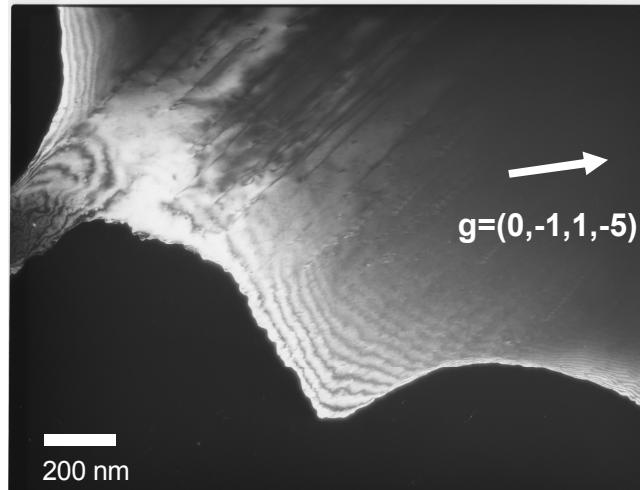
EXTRA

Aggressive ion-milling produces nanoscale artifacts in Bi_2Te_3

Ion Milled (Gatan DualMill 5 kV Ar+)

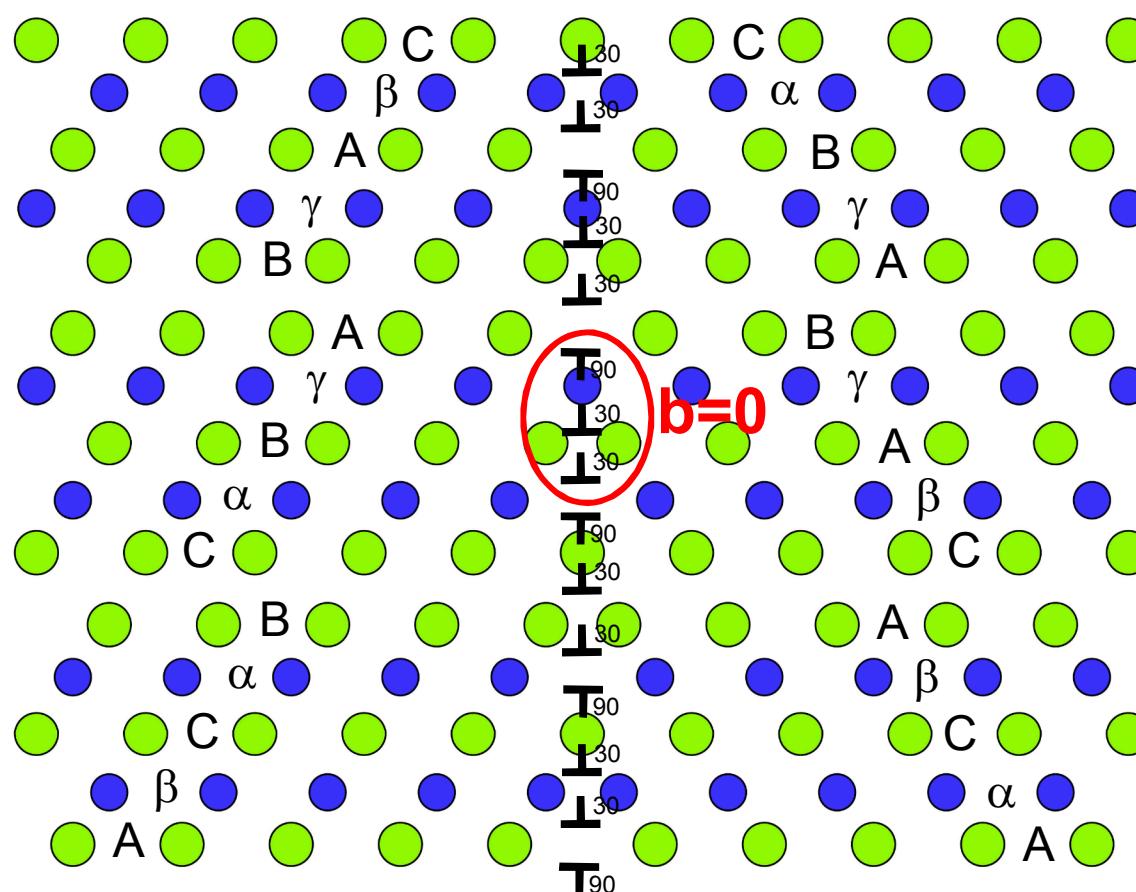


Electrochemical Polish



Can avoid artifacts using low-voltage, low-angle ion milling with cryo-cooling

Schematic of Bi_2Te_3 {10-10} twin



Analogous dislocation structure to FCC {112} twin facets?

Migration by coordinated motion of 30° and 90° $1/3<10-10>$ twinning dislocations